2020-05-07 Rev.2.0

TOSHIBA

RD Number: RD076

RD Title: TB67S179FTG Evaluation circuit BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	IC1	1	TB67S179FTG	TB67S179FTG	TOSHIBA	Motor driver IC	QFN48	
2	VM	1	Check terminal	_	_	Check terminal for logic		
3	GND	1	Check terminal	_	_	Check terminal for logic		
4	VREF	1	Check terminal	_	_	Check terminal for logic		
5	VDD	1	Check terminal	_	_	Check terminal for oscilloscope		
6	ERR	1	Check terminal	_	_	Check terminal for oscilloscope		
7	ALM	1	Check terminal	_	_	Check terminal for oscilloscope		
8	МО	1	Check terminal	_	_	Check terminal for oscilloscope		
9	LOUT	0	Check terminal	_	_	Check terminal for oscilloscope		✓
10	COUT	0	Check terminal	_	_	Check terminal for oscilloscope		✓
11	DOUT	0	Check terminal	_	_	Check terminal for oscilloscope		✓
12	45	1	Check terminal	_	_	Check terminal for oscilloscope		
13	46	1	Check terminal	_	_	Check terminal for oscilloscope		
14	47	1	Check terminal	_	_	Check terminal for oscilloscope		
15	48	1	Check terminal	_	_	Check terminal for oscilloscope		
16	3	1	Check terminal	_	_	Check terminal for oscilloscope		
17	5	1	Check terminal	_	_	Check terminal for oscilloscope		
18	6	1	Check terminal	_	_	Check terminal for oscilloscope		
19	7	1	Check terminal	_	_	Check terminal for oscilloscope		
20	OUTA+	1	Check terminal	_	_	Check terminal for logic		
21	OUTA-	1	Check terminal	_	_	Check terminal for logic		
22	OUTB+	1	Check terminal			Check terminal for logic		
23	OUTB-	1	Check terminal	_	_	Check terminal for logic		
24	COMA	1	Check terminal	_	_	Check terminal for logic		
25	СОМВ	1	Check terminal			Check terminal for logic		

26	ZD	1	CMZ36	CMZ36	TOSHIBA	Zener diode Vz=36V	M-FLAT	
27	R351	0	Not mount	_	_	Leaded resistor		✓
28	R352	0	Not mount	_	_	Leaded resistor		✓
29	R37	1	10kΩ	_	_	Leaded resistor		
30	R38	1	10kΩ	_	_	Leaded resistor		
31	R39	1	10kΩ	_	_	Leaded resistor		
32	R40	1	10kΩ	_	_	Leaded resistor		
33	C312	1	0.1µF 50V	_	_	Chip capacitor	3.2mm×1.6mm	
34	C33	1	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	
35	C35	1	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	
36	CDD	1	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	
37	C13	0	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	✓
38	C17	0	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	✓
39	C19	0	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	✓
40	C23	0	0.1µF 25V	_	_	Chip capacitor	3.2mm×1.6mm	✓
41	C311	1	100μF 50V	_	_	Electrolytic capacitor		
42	SW3	0	Pin header 3P	_	_	Single row plugs		✓
43		0	Jump socket	_	_	Position Shunt Connector		✓
44	SW5	1	Pin header 3P	_	_	Single row plugs		
45		1	Jump socket	_	_	Position Shunt Connector		
46	SW6	1	Pin header 3P	_	_	Single row plugs		
47		1	Jump socket	_	_	Position Shunt Connector		
48	SW7	1	Pin header 3P	_	_	Single row plugs		
49		1	Jump socket	_	_	Position Shunt Connector		
50	SW45	1	Pin header 3P	_	_	Single row plugs		
51		1	Jump socket	_	_	Position Shunt Connector		
52	SW46	1	Pin header 3P	_	_	Single row plugs		
53		1	Jump socket	_	_	Position Shunt Connector		_
54	SW47	1	Pin header 3P	_	_	Single row plugs		
55		1	Jump socket	_	_	Position Shunt Connector		
56	SW48	1	Pin header 3P	_	_	Single row plugs		
57		1	Jump socket	_	_	Position Shunt Connector		

58	CON1	1	Connector	_	_	CONN HEADER VERT 6POS	
59	CON2	0	Connector	_	_	CONN HEADER VERT 3POS	✓
60	CON3	0	Connector	_	_	CONN HEADER VERT 3POS	✓
61	JPCC	1	Pin header 2P	_	_	Single row plugs	
62		1	Jump socket	_	_	Position Shunt Connector	

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